

# 400μA High-Speed Operational Amplifier

■ OptimWatt<sup>TM</sup> device featuring ultra-low consumption, 2mW, and low quiescent current, 400µA

■ Bandwidth: 120MHz (Gain=2)

Slew rate: 115V/μs
 Specified on 1kΩ
 Input noise: 7.5nV/√Hz
 Tested on 5V power supply

#### **Description**

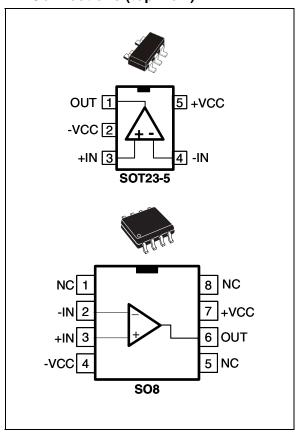
The TSH310 is a very low-power, high-speed operational amplifier. A bandwidth of 120MHz is achieved while drawing only  $400\mu A$  of quiescent current. This low-power characteristic is particularly suitable for high-speed, battery-powered equipment requiring dynamic performance.

The TSH310 is a single operator available in SO8 and the tiny SOT23-5 plastic package, saving board space as well as providing excellent thermal performances.

#### **Applications**

- Battery-powered and high-speed systems
- Communication & video test equipment
- Portable medical instrumentation
- ADC drivers

## Pin Connections (top view)



#### **Order Codes**

Part Number	Temperature Range	Package	Conditioning	Marking
TSH310ILT		SOT23-5	Tape&Reel	K304
TSH310ID	-40°C to +85°C	SO-8	Tube	TSH310I
TSH310IDT		SO-8	Tape&Reel	TSH310I

Note: OptimWatt<sup>TM</sup> is an STMIcroelectronics registered trademark that applies to products with specific features that optimize energy efficiency.

## 1 Absolute Maximum Ratings

Table 1: Key parameters and their absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage <sup>1</sup>	6	V
V <sub>id</sub>	Differential Input Voltage <sup>2</sup>	+/-0.5	V
V <sub>in</sub>	Input Voltage Range <sup>3</sup>	+/-2.5	V
T <sub>oper</sub>	Operating Free Air Temperature Range	-40 to +85	°C
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>j</sub>	Maximum Junction Temperature	150	°C
R <sub>thja</sub>	Thermal Resistance Junction to Ambient SOT23-5 SO8	250 150	°C/W
R <sub>thjc</sub>	Thermal Resistance Junction to Case SOT23-5 SO8	80 28	°C/W
P <sub>max</sub>	Maximum Power Dissipation <sup>4</sup> (@Ta=25°C) for Tj=150°C SOT23-5 SO8	500 830	mW
	HBM: Human Body Model <sup>5</sup> (pins 1, 4, 5, 6, 7 and 8)	2	kV
	HBM: Human Body Model (pins 2 and 3)	0.5	kV
ESD	MM: Machine Model <sup>6</sup> (pins 1, 4, 5, 6, 7 and 8)	200	٧
	MM: Machine Model (pins 2 and 3)	60	V
	CDM: Charged Device Model (pins 1, 4, 5, 6, 7 and 8)	1.5	kV
	CDM: Charged Device Model (pins 2 and 3)	1.5	kV
	Latch-up Immunity	200	mA

<sup>1)</sup> All voltages values are measured with respect to the ground pin.

**Table 2: Operating conditions** 

Symbol	Parameter	Value	Unit
v <sub>cc</sub>	Supply Voltage <sup>1</sup>	4.5 to 5.5	٧
V <sub>icm</sub>	Common Mode Input Voltage	-Vcc+1.5V, +Vcc-1.5V	V

1) Tested in full production at 5V (±2.5V) supply voltage.

<sup>2)</sup> Differential voltage are non-inverting input terminal with respect to the inverting input terminal.

<sup>3)</sup> The magnitude of input and output voltage must never exceed  $V_{CC}$  +0.3V.

<sup>4)</sup> Short-circuits can cause excessive heating. Destructive dissipation can result from short circuit on amplifiers.

<sup>5)</sup> Human body model, 100pF discharged through a  $1.5k\Omega$  resistor into pMin of device.

<sup>6)</sup> This is a minimum Value. Machine model ESD, a 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (internal resistor  $< 5\Omega$ ), into pin to pin of device.

## **2 Electrical Characteristics**

Table 3: Electrical characteristics for  $V_{CC} = \pm 2.5 \text{Volts}$ ,  $T_{amb} = 25 ^{\circ}\text{C}$  (unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit	
DC perfo	ormance						
V <sub>io</sub>	Input Offset Voltage	$T_{amb}$		1.7	6.5	m\/	
v <sub>io</sub>	Offset Voltage between both inputs	$T_{min.} < T_{amb} < T_{max.}$		2.1		mV	
$\Delta V_{io}$	V <sub>io</sub> drift vs. Temperature	$T_{min.} < T_{amb} < T_{max.}$		4		μV/°C	
I	Non Inverting Input Bias Current	T <sub>amb</sub>		3.1	12	μА	
I <sub>ib+</sub>	DC current necessary to bias the input +	$T_{\text{min.}} < T_{\text{amb}} < T_{\text{max.}}$		3.5		μΛ	
I <sub>ib-</sub>	Inverting Input Bias Current	$T_{amb}$		0.1	5	μA	
'lb-	DC current necessary to bias the input -	$T_{\text{min.}} < T_{\text{amb}} < T_{\text{max.}}$		0.3		μΛ	
CMR	Common Mode Rejection Ratio	$\Delta V_{ic} = \pm 1 V$	-57	-61		dB	
Civilii	20 log $(\Delta V_{io}/\Delta V_{io})$	$T_{\text{min.}} < T_{\text{amb}} < T_{\text{max.}}$		-59		GD.	
SVR	Supply Voltage Rejection Ratio	$\Delta V_{cc}$ = 3.5V to 5V	-65	-82		dB	
OVII	20 log (Δ <i>Vcc</i> /Δ <i>Vio</i> )	$T_{\text{min.}} < T_{\text{amb}} < T_{\text{max.}}$		-79		G	
	Power Supply Rejection Ratio	$AV = +1$ , $\Delta V_{cc} = \pm 100$ mV		-50			
PSR	$20 \log (\Delta V_{cc}/\Delta V_{out})$	at 1kHz				dB	
	- ···	$T_{min.} < T_{amb} < T_{max.}$		46			
ICC	Positive Supply Current DC consumption with no input signal	No load		400	530	μΑ	
Dynamic	performance and output characte	eristics		ı			
	Transimpedance	$R_L = 1k\Omega, V_{out} = \pm 1V$	0.6	1.45		MΩ	
R <sub>OL</sub>	Output Voltage/Input Current Gain in open loop of a CFA. For a VFA, the analog of this feature is the Open Loop Gain (A <sub>VD</sub> )	$T_{min.} < T_{amb} < T_{max.}$		1.36		МΩ	
Bw	-3dB Bandwidth Frequency where the gain is 3dB below the DC gain A <sub>V</sub> Note: Gain Bandwidth Product criterion is not applicable for Current-Feedback- Amplifiers	$\begin{split} &\text{Small Signal V}_{out} = 20\text{mVp-p} \\ &\text{RL} = 1k\Omega \\ &\text{AV} = +1, \ R_{fb} = 3k\Omega \\ &\text{AV} = +2, \ R_{fb} = 3k\Omega \\ &\text{AV} = +10, \ R_{fb} = 510\Omega \end{split}$	80	230 120 26		MHz	
	Gain Flatness @ 0.1dB Band of frequency where the gain variation does not exceed 0.1dB	Small Signal Vout=20mVp-p AV = +2, RL = $1k\Omega$		25			
SR	Slew Rate Maximum output speed of sweep in large signal	$V_{out} = 2Vp-p, A_V = +2,$ $R_L = 1k\Omega$	75	115		V/µs	
V <sub>OH</sub>	High Level Output Voltage	$R_L = 1k\Omega$	1.55	1.65		٧	
<b>∨</b> ОН		$T_{min.} < T_{amb} < T_{max.}$		1.58			
V	Low Level Output Voltage	$R_L = 1k\Omega$		-1.66	-1.55	V	
$V_{OL}$		$T_{min.} < T_{amb} < T_{max.}$		-1.60			



Table 3: Electrical characteristics for  $V_{CC}$  = ±2.5Volts,  $T_{amb}$  = 25°C (unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
l <sub>out</sub>	Isink	Output to GND	70	110		
	Short-circuit Output current coming in the op-amp. See fig-8 for more details	$T_{min.} < T_{amb} < T_{max.}$		100		mA
	Isource	Output to GND	60	100		IIIA
	Output current coming out from the opamp. See fig-11 for more details	$T_{min.} < T_{amb} < T_{max.}$		85		
Noise and distortion						
eN	Equivalent Input Noise Voltage see application note on page 13	F = 100kHz		7.5		nV/√Hz
iN	Equivalent Input Noise Current (+) see application note on page 13	F = 100kHz		13		pA/√Hz
IIN	Equivalent Input Noise Current (-) see application note on page 13	F = 100kHz		6		pA/√Hz
SFDR	Spurious Free Dynamic Range The highest harmonic of the output spectrum when injecting a filtered sine wave	$V_{out} = 2Vp-p, A_V = +2,$ $R_L = 1k\Omega$ $F = 1MHz$ $F = 10MHz$		-87 -55		dBc dBc

Table 4: Closed-loop gain and feedback components

V <sub>CC</sub> (V)	Gain	R <sub>fb</sub> (Ω)	-3dB Bw (MHz)	0.1dB Bw (MHz)
	+10	510	26	4
±2.5	-10	510	23	4
	+2	3k	120	6
	-2	1.5k	80	10
	+1	3k	210	5
	-1	1.3k	120	60

Figure 1: Frequency Response, positive Gain

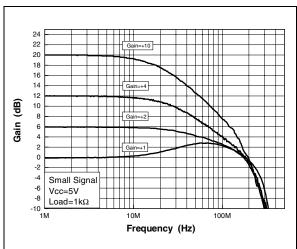


Figure 2: Gain Flatness, gain=+4

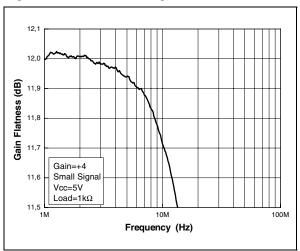


Figure 3: Frequency response vs. capa-load

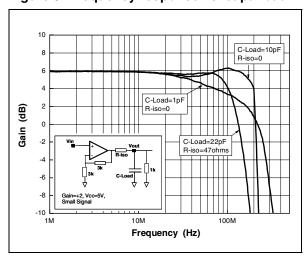


Figure 4: Frequency response, negative gain

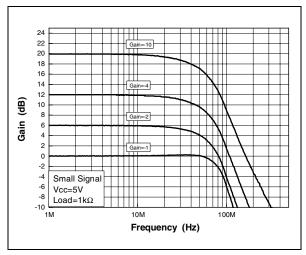


Figure 5: Gain flatness, gain=+2

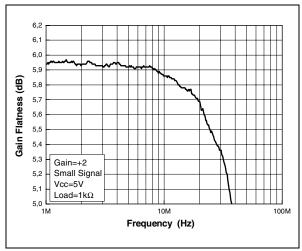


Figure 6: Step response vs. capa-load

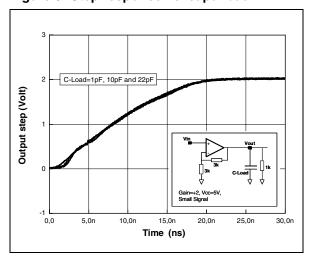


Figure 7: Slew rate

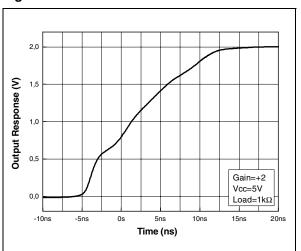


Figure 8: Isink

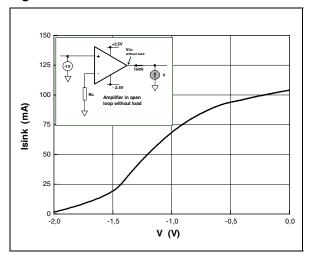


Figure 9: Output amplitude vs. load

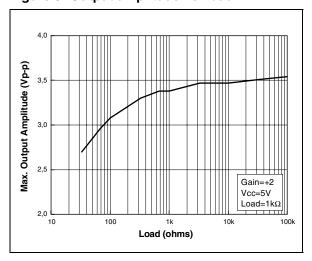


Figure 10: Quiescent current vs. Vcc

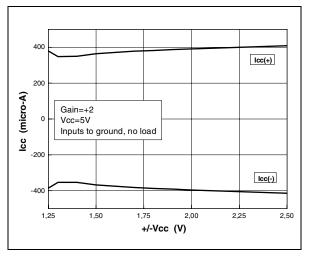


Figure 11: Isource

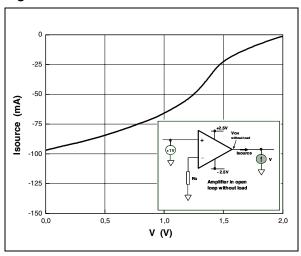


Figure 12: Input voltage noise vs. frequency

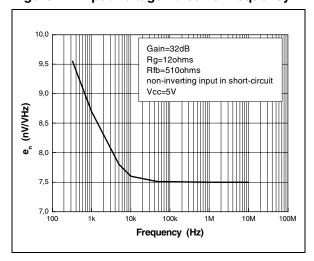


Figure 13: Distortion vs. output amplitude

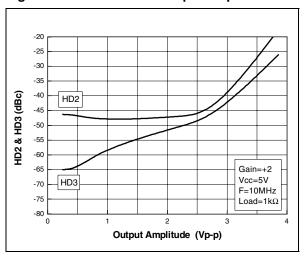


Figure 14: Output amplitude vs. frequency

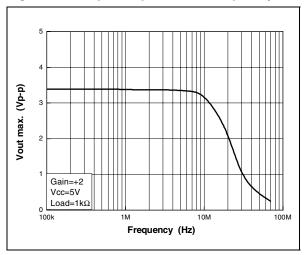


Figure 15: Bandwidth vs. temperature

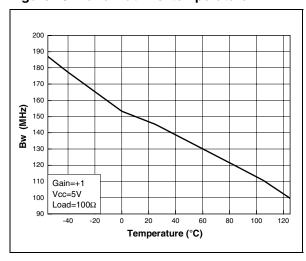


Figure 16: CMR vs. temperature

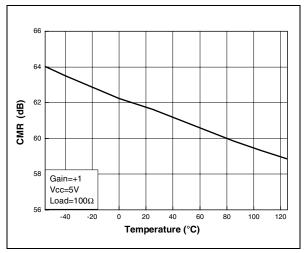


Figure 17: SVR vs. temperature

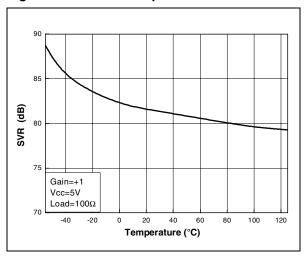


Figure 18: Slew-Rate vs. temperature

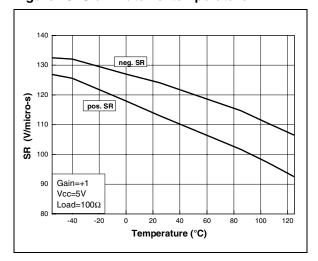


Figure 19: ROL vs. temperature

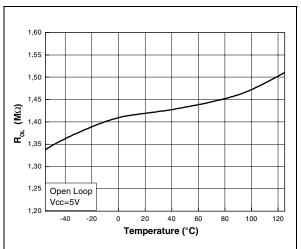


Figure 20: I-bias vs. temperature

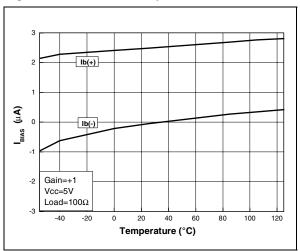


Figure 21: Vio vs. temperature

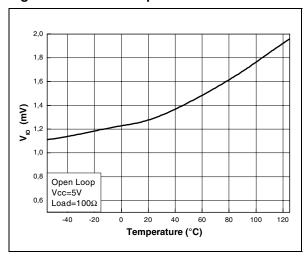


Figure 22: VOH & VOL vs. temperature

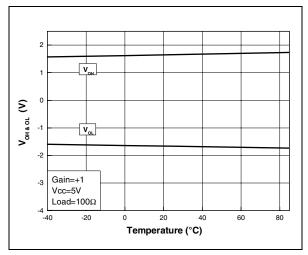


Figure 23: Icc vs. temperature

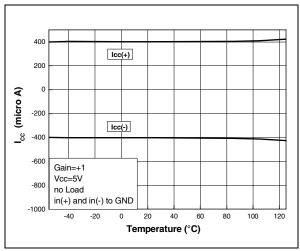
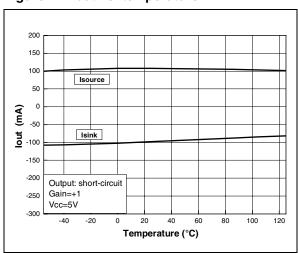


Figure 24: lout vs. temperature



Evaluation Boards TSH310

#### 3 Evaluation Boards

An evaluation board kit optimized for high-speed operational amplifiers is available (order code: KITHSEVAL/STDL). The kit includes the following evaluation boards, as well as a CD-ROM containing datasheets, articles, application notes and a user manual:

- SOT23\_SINGLE\_HF BOARD: Board for the evaluation of a single high-speed op-amp in SOT23-5 package.
- SO8\_SINGLE\_HF: Board for the evaluation of a single high-speed op-amp in SO8 package.
- SO8\_DUAL\_HF: Board for the evaluation of a dual high-speed op-amp in SO8 package.
- SO8\_S\_MULTI: Board for the evaluation of a single high-speed op-amp in SO8 package in inverting and non-inverting configuration, dual and single supply.
- SO14\_TRIPLE: Board for the evaluation of a triple high-speed op-amp in SO14 package with video application considerations.

#### **Board material:**

- 2 layers
- FR4 (Er=4.6)
- epoxy 1.6mm
- copper thickness: 35µm

Figure 25: Evaluation kit for high-speed op-amps

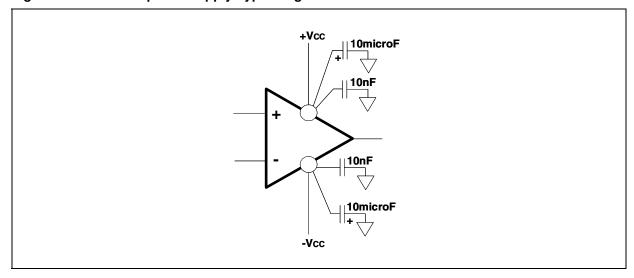


#### 4 Power Supply Considerations

Correct power supply bypassing is very important for optimizing performance in high-frequency ranges. Bypass capacitors should be placed as close as possible to the IC pins to improve high-frequency bypassing. A capacitor greater than  $1\mu F$  is necessary to minimize the distortion. For better quality bypassing, a capacitor of 10nF can be added using the same implementation conditions. Bypass capacitors must be incorporated for both the negative and the positive supply.

For example: on the SO8\_SINGLE\_HF board, these capacitors are C6, C7, C8, C9.

Figure 26: Circuit for power supply bypassing



#### Single power supply

In the event that a single supply system is used, new biasing is necessary to assume a positive output dynamic range between 0V and  $+V_{CC}$  supply rails. Considering the values of VOH and VOL, the amplifier will provide an output dynamic from +0.9V to +4.1V on  $1k\Omega$  load.

The amplifier must be biased with a mid-supply (nominally  $+V_{CC}/2$ ), in order to maintain the DC component of the signal at this value. Several options are possible to provide this bias supply, such as a virtual ground using an operational amplifier or a two-resistance divider (which is the cheapest solution). A high resistance value is required to limit the current consumption. On the other hand, the current must be high enough to bias the non-inverting input of the amplifier. If we consider this bias current ( $55\mu A$  max.) as the 1% of the current through the resistance divider to keep a stable mid-supply, two resistances of  $470\Omega$  can be used.

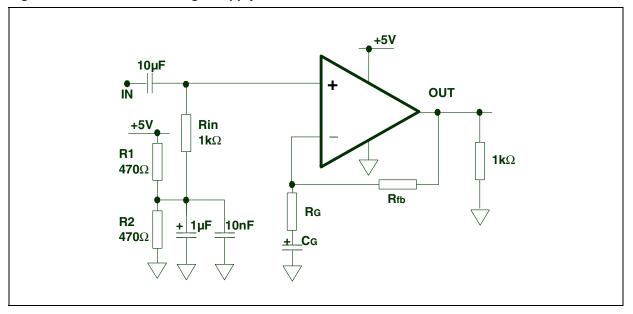
The input provides a high pass filter with a break frequency below 10Hz which is necessary to remove the original 0 volt DC component of the input signal, and to fix it at  $+V_{CC}/2$ .

*Figure 27* illustrates a 5V single power supply configuration for the SO8\_SINGLE evaluation board (see *Evaluation Boards* on page 9).

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A capacitor  $C_G$  is added in the gain network to ensure a unity gain in low frequency to keep the right DC component at the ouput.  $C_G$  contributes to a high-pass filter with  $R_{fb}$ // $R_G$  and its value is calculated with a consideration of the cut-off frequency of this low-pass filter.

Figure 27: Circuit for +5V single supply



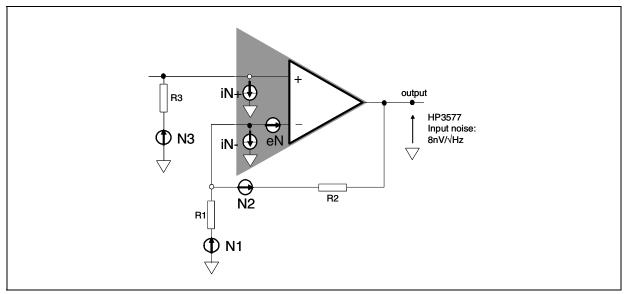
TSH310 Noise Measurements

#### 5 Noise Measurements

The noise model is shown in Figure 28, where:

- eN: input voltage noise of the amplifier
- iNn: negative input current noise of the amplifier
- iNp: positive input current noise of the amplifier

Figure 28: Noise model



The thermal noise of a resistance R is:

$$\sqrt{4kTR\Delta F}$$

where  $\Delta F$  is the specified bandwidth.

On a 1Hz bandwidth the thermal noise is reduced to

where k is the Boltzmann's constant, equal to 1,374.10-23J/°K. T is the temperature (°K).

The output noise eNo is calculated using the Superposition Theorem. However eNo is not the simple sum of all noise sources, but rather the square root of the sum of the square of each noise source, as shown in *Equation 1*:

$$eNo = \sqrt{V1^2 + V2^2 + V3^2 + V4^2 + V5^2 + V6^2}$$
 Equation 1

$$eNo^{2} = eN^{2} \times g^{2} + iNn^{2} \times R2^{2} + iNp^{2} \times R3^{2} \times g^{2} + \frac{R2^{2}}{R1} \times 4kTR1 + 4kTR2 + 1 + \frac{R2^{2}}{R1} \times 4kTR3 \qquad \textit{Equation 2}$$

Noise Measurements TSH310

The input noise of the instrumentation must be extracted from the measured noise value. The real output noise value of the driver is:

eNo = 
$$\sqrt{\text{(Measured)}^2 - \text{(instrumentation)}^2}$$
 Equation 3

The input noise is called the Equivalent Input Noise as it is not directly measured but is evaluated from the measurement of the output divided by the closed loop gain (eNo/g).

After simplification of the fourth and the fifth term of *Equation 2* we obtain:

$$eNo^2 = eN^2 \times g^2 + iNn^2 \times R2^2 + iNp^2 \times R3^2 \times g^2 + g \times 4kTR2 + 1 + \frac{R2^2}{R1} \times 4kTR3$$
 Equation 4

#### Measurement of the input voltage noise eN

If we assume a short-circuit on the non-inverting input (R3=0), from Equation 4 we can derive:

$$eNo = \sqrt{eN^2 \times g^2 + iNn^2 \times R2^2 + g \times 4kTR2}$$
 Equation 5

In order to easily extract the value of eN, the resistance R2 will be chosen to be as low as possible. In the other hand, the gain must be large enough:

#### Measurement of the negative input current noise iNn

To measure the negative input current noise iNn, we set R3=0 and use *Equation 5*. This time the gain must be lower in order to decrease the thermal noise contribution:

#### Measurement of the positive input current noise iNp

To extract iNp from *Equation 3*, a resistance R3 is connected to the non-inverting input. The value of R3 must be chosen in order to keep its thermal noise contribution as low as possible against the iNp contribution:

R3=100
$$\Omega$$
, gain: g=10

#### 6 Intermodulation Distortion Product

The non-ideal output of the amplifier can be described by the following series:

Vout = 
$$C_0 + C_1 V_{in} + C_2 V_{in}^2 + ... +$$

due to non-linearity in the input-output amplitude transfer, where the input is  $V_{in}$ =Asin $\omega$ t,  $C_0$  is the DC component,  $C_1(V_{in})$  is the fundamental and  $C_n$  is the amplitude of the harmonics of the output signal  $V_{out}$ .

A one-frequency (one-tone) input signal contributes to harmonic distortion. A two-tone input signal contributes to harmonic distortion and to the intermodulation product.

The study of the intermodulation and distortion for a two-tone input signal is the first step in characterizing the driving capability of multi-tone input signals.

In this case:

$$V_{in} = A \sin \omega_1 t + A \sin \omega_2 t$$

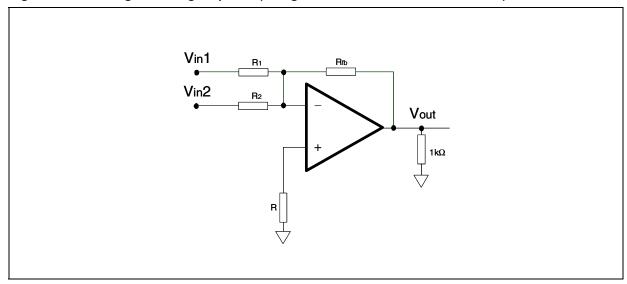
then:

$$V_{out} = C_0 + C_1 (A\sin\omega_1 t + A\sin\omega_2 t) + C_2 (A\sin\omega_1 t + A\sin\omega_2 t)^2 \dots + C_n (A\sin\omega_1 t + A\sin\omega_2 t)^n$$

From this expression, we can extract the distortion terms, and the intermodulation terms form a single sine wave: second-order intermodulation terms IM2 by the frequencies  $(\omega_1-\omega_2)$  and  $(\omega_1+\omega_2)$  with an amplitude of C2A<sup>2</sup> and third-order intermodulation terms IM3 by the frequencies  $(2\omega_1-\omega_2)$ ,  $(2\omega_1+\omega_2)$ ,  $(-\omega_1+2\omega_2)$  and  $(\omega_1+2\omega_2)$  with an amplitude of  $(3/4)C3A^3$ .

The measurement of the intermodulation product of the driver is achieved by using the driver as a mixer by a summing amplifier configuration (see *Figure 29*). In this way, the non-linearity problem of an external mixing device is avoided.

Figure 29: Inverting summing amplifier (using evaluation board SO8\_S\_MULTI)



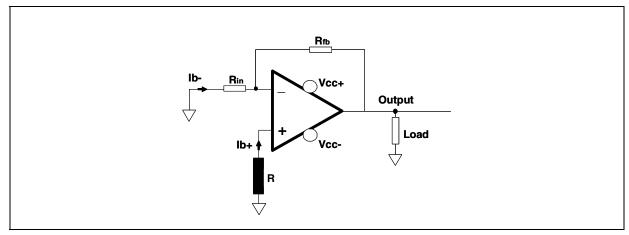
### 7 The Bias of an Inverting Amplifier

A resistance is necessary to achieve a good input biasing, such as resistance R shown in Figure 30.

The magnitude of this resistance is calculated by assuming the negative and positive input bias current. The aim is to compensate for the offset bias current, which could affect the input offset voltage and the output DC component. Assuming Ib-, Ib+, R<sub>in</sub>, R<sub>fb</sub> and a zero volt output, the resistance R will be:

$$R = \frac{R_{in} \times R_{fb}}{R_{in} + R_{fb}}$$

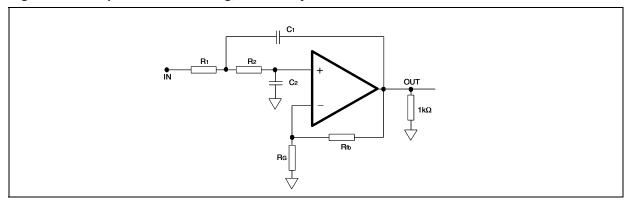
Figure 30: Compensation of the input bias current



TSH310 Active Filtering

#### 8 Active Filtering

Figure 31: Low-pass active filtering, Sallen-Key



From the resistors  $R_{fb}$  and  $R_{G}$  we can directly calculate the gain of the filter in a classical non-inverting amplification configuration:

$$A_V = g = 1 + \frac{R_{fb}}{R_g}$$

We assume the following expression as the response of the system:

$$T_{j\omega} = \frac{Vout_{j\omega}}{Vin_{j\omega}} = \frac{g}{1 + 2\zeta \frac{j\omega}{\omega_c} + \frac{(j\omega)^2}{\omega_c^2}}$$

The cut-off frequency is not gain-dependent and so becomes:

$$\omega_{\text{C}} = \frac{1}{\sqrt{\text{R1R2C1C2}}}$$

The damping factor is calculated by the following expression:

$$\zeta = \frac{1}{2}\omega_{\rm c}({\rm C_1R_1} + {\rm C_1R_2} + {\rm C_2R_1} - {\rm C_1R_1g})$$

The higher the gain, the more sensitive the damping factor is. When the gain is higher than 1, it is preferable to use some very stable resistor and capacitor values. In the case of R1=R2=R:

$$\zeta = \frac{2C_2 - C_1 \frac{R_{fb}}{R_g}}{2\sqrt{C_1 C_2}}$$

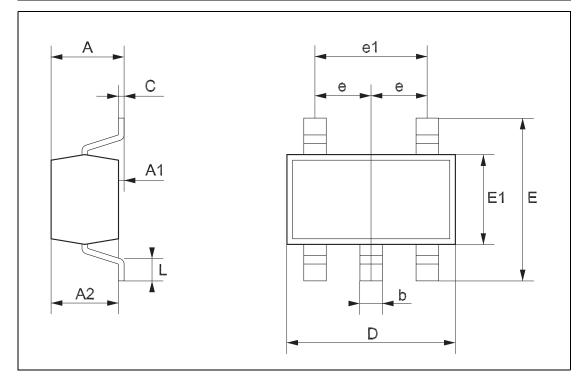
Due to a limited selection of values of capacitors in comparison with resistors, we can fix C1=C2=C, so that:

$$\zeta = \frac{2R_2 - R_1 \frac{R_{fb}}{R_g}}{2\sqrt{R_1 R_2}}$$

## 9 Package Mechanical Data

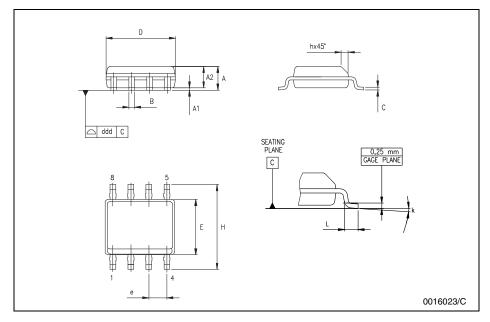
## **SOT23-5L MECHANICAL DATA**

DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.0		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
С	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
е		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6



#### **SO-8 MECHANICAL DATA**

DIM		mm.			inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.		
Α	1.35		1.75	0.053		0.069		
A1	0.10		0.25	0.04		0.010		
A2	1.10		1.65	0.043		0.065		
В	0.33		0.51	0.013		0.020		
С	0.19		0.25	0.007		0.010		
D	4.80		5.00	0.189		0.197		
E	3.80		4.00	0.150		0.157		
е		1.27			0.050			
Н	5.80		6.20	0.228		0.244		
h	0.25		0.50	0.010		0.020		
L	0.40		1.27	0.016		0.050		
k			8° (r	nax.)				
ddd			0.1			0.04		



Revision History TSH310

### 10 Revision History

Date	Revision	Description of Changes
01 Oct 2004	1	First release corresponding to Preliminary Data version of datasheet.
December 2004	2	Release of mature product datasheet.

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